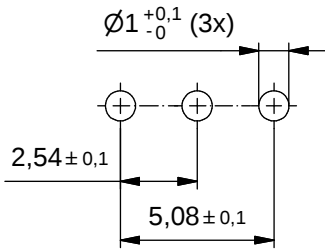


PCB hole drillings
(PCB top side)/
Leiterplattenbohrbild
(Leiterplatten Oberseite)



Technical specification:

Technische Daten:

Frequency Range/
Frequenzbereich: 0 - 2 GHz

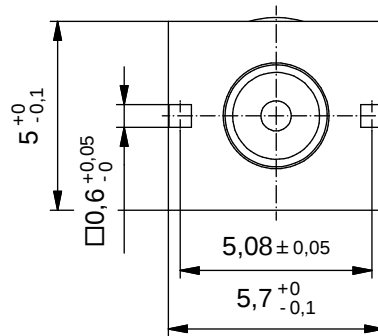
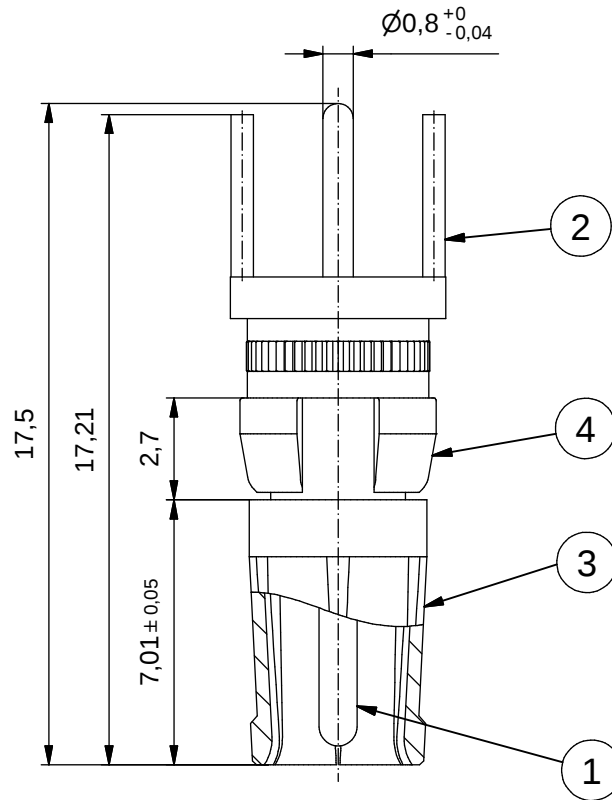
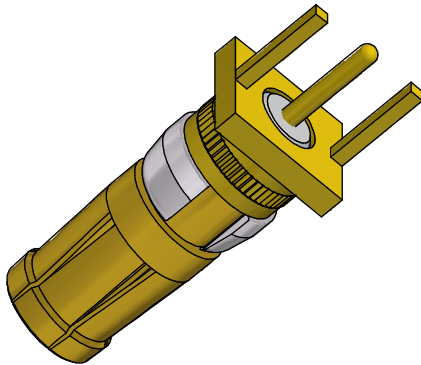
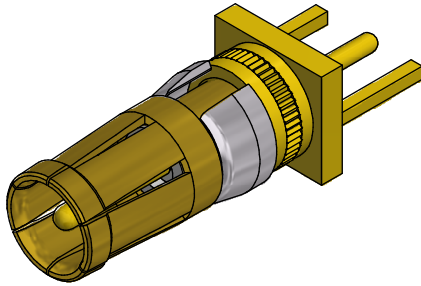
Impedance/
Impedanz: 75 Ω

Materials/

Werkstoffe:

Contact/
Kontakt: Cu alloy

Insulator/
Isolator: PTFE / POM



(b)

Part no. / Art.-Nr.:	Plating pos. 1/ Veredelung Pos. 1:	Plating pos. 2/ Veredelung Pos. 2:	Plating pos. 3/ Veredelung Pos. 3:	Plating pos. 4/ Veredelung Pos. 4:
132A34019X	Gold flash over nickel/ Gold über Nickel	Gold flash over nickel/ Gold über Nickel	Gold flash over nickel/ Gold über Nickel	Nickel plated/ vernickelt
132J34019X	min. 50 µm hard gold over min. 50 µm nickel min. 50 µm Gold über min. 50 µm Nickel	Gold flash over nickel/ Gold über Nickel	min. 30 µm hard gold over min. 50 µm nickel min. 30 µm Gold über min. 50 µm Nickel	Nickel plated/ vernickelt
dim. in mm drawn/ gez. 02.02.2018 Lehmenkühler appd./ gepr. 02.02.2018 Koch		Coaxial socket contact 75 Ohm solder termination straight (86) with 3 pins Koaxial Buchsen Kontakt 75 Ohm Lötanschluss gerade (86) mit 3 Pins		
		dwg no / Z.-nr.: 13K1A5515		
		DIN-A4 1 / 1		
Index: b Ä7098 02.02.2018 J.L.	scale/Maßstab: 4 : 1	CONEC®		
Status: InBearbeitung				
RoHS compliant/konform				